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230 s room-temperature storage time and 1.14 eV hole localization energy in In0.5Ga0.5As quantum dots on a GaAs interlayer in GaP with an AIP barrier

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A GaP \(n^+\)p-diode containing In0.5Ga0.5As quantum dots (QDs) and an AIP barrier is characterized electrically, together with two reference samples: a simple \(n^+\)p-diode and an \(n^+\)p-diode with AIP barrier. Localization energy, capture cross-section, and storage time for holes in the QDs are determined using deep-level transient spectroscopy. The localization energy is 1.14(±0.04) eV, yielding a storage time at room temperature of 230(±60) s, which marks an improvement of 2 orders of magnitude compared to the former record value in QDs. Alternative material systems are proposed for still higher localization energies and longer storage times. © 2015 AIP Publishing LLC.

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At present, solid-state memory technology is fundamentally divided into volatile memories (e.g., DRAM) and non-volatile memories (e.g., Flash). Overcoming this divide by developing fast-access non-volatile memory “would initiate a revolution in computer architecture.”1 The trade-off between storage time and data access time can be overcome using quantum dots (QDs).2 The potential of QDs as storage elements in memory devices was demonstrated before.3,4 The longest storage of charge carriers in QDs hitherto measured at room temperature is 1.6 s for holes in InAs/GaAs QDs with an Al0.9Ga0.1As barrier2 and the highest measured localization energy is \(E_{loc} = 0.8\) eV for GaSb QDs in GaAs with an Al0.5Ga0.5As barrier.5 8-band \(k \cdot p\) calculations show that storage times longer than 10 years can be obtained by using heterostructures with much larger \(E_{loc}\). In particular, a hole localization energy of about 0.6 eV is expected for In0.5Ga0.5As QDs in GaP.7 An AIP barrier would provide an additional 0.5 eV, yielding a total emission barrier between 1.0 eV and 1.1 eV for holes trapped in the QDs.8

The key to successfully growing InGaAs QDs in GaP using metal-organic chemical vapor deposition (MOCVD) is a GaAs interlayer.9,10 Such QDs with a nominal In content of 25% yield a mean activation energy of 490 meV.5 QDs with an increased In content (50%) were grown and characterized with atomic force microscopy (AFM), cross-sectional scanning tunneling microscopy (X-STM), and photoluminescence spectroscopy (PL).11 However, a measurement of the electronic properties, such as their capture cross-section and activation energy, is still missing.

In this letter, we report on the electronic properties of a set of three samples, the main one containing In0.5Ga0.5As QDs grown on a GaAs interlayer in a GaP matrix, with an additional AIP barrier aimed at increasing the localization energy of holes in the QDs, and thus the storage time. The electronic properties of the QDs are investigated using deep level transient spectroscopy (DLTS)12 in order to determine activation energy and capture cross-section. The storage time at room temperature is extrapolated from these parameters.

Since the electric fields at which the measurements are performed are comparatively small and the temperatures of interest high, tunneling emission from QDs can be neglected13 and the dominating process is thermal emission.14 The thermal emission rate of holes from QDs can be expressed as

\[
e_{\text{th}} = \gamma T^2 \sigma_{\infty} \exp \left( \frac{E_a}{k_B T} \right),
\]

where \(E_a\) is the activation energy, \(k_B\) the Boltzmann constant, \(T\) the temperature, \(\sigma_{\infty}\) the apparent capture cross section for \(T = \infty\), and \(\gamma\) a temperature-independent constant. The storage time is the inverse of the thermal emission rate (\(\tau = 1/e_{\text{th}}\)) and therefore depends solely on the energy barrier (activation energy) \(E_a\), which the holes have to overcome during the emission process, and on the apparent capture cross section \(\sigma_{\infty}\). The cross section measures the probability of scattering free holes from the surrounding matrix into the QD. It is worth pointing out that in our case \(E_a\) will consist of the sum of the localization energy of the QD ensemble and the height of the AIP barrier.

The basic structure of the three measured samples (which is depicted in the inset of Fig. 1) is a GaP \(n^+\)p-diode (sample A), which is used as reference sample. In sample B, a layer of 20 nm AIP is embedded in the \(p^+\)-doped segment of the junction. The lowly \(p^+\)-doped segment of Sample C includes a 20 nm thick AIP layer (which acts as an emission barrier for charge-carriers in the QDs) and a layer of In0.5Ga0.5As QDs separated from the AIP barrier by 2 nm of intrinsic GaP. The QD layer is composed of 0.8 monolayers (ML) of In0.5Ga0.5As deposited on 2 ML of GaAs. The purpose of the GaAs interlayer is to enable the controlled formation of the In0.5Ga0.5As QDs via the Stranki-Krastanow (SK) growth mode.9

All samples were grown on \(p^+\)-doped GaP (001) substrates using MOCVD. The 500 nm thick \(p^+\)-doped

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(p = 2 × 10^{18} \text{cm}^{-3}) GaP contact layer and the 700 nm lowly p-doped (p = 5 × 10^{16} \text{cm}^{-3}) GaP layer were grown at 750°C. The 20 nm AlP barrier and 2 nm GaP were grown at 800°C. For the QD layer, the growth temperature was lowered to 500°C. The purpose of the 2 nm of GaP is to protect the AlP surface from adsorbing impurities while cooling down to the QD growth temperature. Details about the QD growth can be found in Ref. 11. After a growth interruption down to the QD growth temperature, the AlP surface is made wettable and dry etching techniques, yielding round mesa structures with a 20 nm radius. The contacts are evaporated thermally and annealed at 400°C for 3 min, where Ni/Au/Ge/Ge is used for the n-side and Ni/Zn/Au for the p-side.16–18

The samples are characterized with both conventional12 and charge-selective DLTS.6,19 The bias voltage range in which charging and discharging of the QDs occur is determined first by means of capacitance–voltage (C–V) spectroscopy. In conventional DLTS, the reverse bias (V_m) is set such that the QDs are completely discharged at the beginning of the measurement. The DLTS cycle starts with a forward bias pulse (V_p) to charge the QDs. Then, the applied voltage returns to the measurement (reverse) bias and the capacitance transient due to the discharge of the QDs is observed. The emission times at different temperatures are obtained using the double box–car averaging technique and are then plotted in an Arrhenius plot to calculate E_a and \sigma_\infty. In the charge-selective DLTS mode, the write pulse is much smaller and chosen in such a way that only a few holes (ideally one hole per QD) enter and leave the QDs in each cycle. The DLTS cycle is then repeated with a different reverse bias, thus probing all internal levels of the QDs. The capacitance transients are measured at a frequency of 1 MHz and an AC voltage of 100 mV.

**Sample A:** For conventional DLTS, the measurement bias is set to V_m = 7.0 V (reverse) and the pulse to V_p = −1.0 V (forward). For charge-selective DLTS, the measurement bias ranges from V_m = 7.0 V to V_m = 0.0 V in steps of 1.0 V, while pulsing to V_p = V_m − 1.0 V.

**Sample B:** Conventional: V_m = 7.0 V, V_p = −1.0 V. Charge-selective: V_m = 7.0 V to V_m = 0.0 V in steps of 1.0 V, V_p = V_m − 1.0 V.

**Sample C:** Conventional: V_m = 7.0 V, V_p = −1.0 V. Charge-selective: V_m = 6.5 V to V_m = 0.0 V in steps of 0.5 V, V_p = V_m − 0.5 V.

The temperature is swept from 100 K to 400 K in steps of 1.5 K. In all measurements, the charging pulse lasted 2 s and the discharge transient was recorded for 18 s. We chose the pulse width such that the charging process was always completed before the pulse ended.

All DLTS measurements were analysed using \tau_{ref} ranging from 4 ms to 10.6 s. The conventional DLTS measurements are shown in Fig. 1 for all samples for a reference time \tau_{ref} = 190 ms. As expected, the reference sample (A) shows no relevant features. Moreover, the peaks shown by samples B and C are clearly separated in temperature, indicating that they have a different origin. The mean, ensemble activation energies are listed in Table I, along with their error.

The charge-selective DLTS measurements on sample C are presented in Fig. 2. Fig. 3 compares the activation energies and capture cross sections extracted from the charge-selective DLTS measurements on samples B and C.

The peak in Fig. 2 remains at the same temperature for all voltages V_m ≤ 2.5 V. At that point, it starts shifting to higher temperatures, until it disappears completely for V_m = 6.0 V and V_m = 6.5 V. Correspondingly, the measured activation energy (Fig. 3(a)) starts off at about 0.90 ± 0.01 eV and gradually increases until 1.40 ± 0.07 eV for V_m = 5.5 V. The capture cross-section (Fig. 3(b)) follows a similar pattern, starting off at about 4(±1) × 10^{-13} \text{cm}^2 and increasing until 4(±6) × 10^{-6} \text{cm}^2. Since the peak for V_m = 5.5 V is very small, the accuracy of the estimate of the corresponding activation energy is also small. Furthermore, the activation energies for V_m = 5.0 V and V_m = 4.5 V appear to be very close to

\begin{table}[h]
\centering
\begin{tabular}{|c|c|c|}
\hline
Sample & E_a (eV) & \sigma_\infty (\text{cm}^2) \\
\hline
A & — & — \\
B & 0.47(±0.07) & 3.8(±0.9) × 10^{-17} \\
C & 0.59(±0.09) & 2.1(±0.5) × 10^{-17} \\
\hline
\end{tabular}
\caption{Mean, ensemble activation energies for samples B and C. Sample A does not show any peak.}
\end{table}

**FIG. 1.** Comparison of conventional DLTS measurements on the different samples (offset for reading ease). Inset: Sketch of sample structure.

**FIG. 2.** Charge-selective DLTS measurements on sample C for reference time \tau_{ref} = 40 ms. The schematic emission process from the QDs is sketched and pointed to the corresponding signal.
each other. On closer inspection, their activation energies and capture cross-sections are compatible within their experimental error ($E_a = 1.12(\pm 0.04)$ eV, $\sigma_\infty = 5(\pm 5) \times 10^{-10}$ cm$^2$ and $E_a = 1.16(\pm 0.02)$ eV, $\sigma_\infty = 1.1(\pm 0.5) \times 10^{-9}$ cm$^2$, respectively) and we therefore interpret the two data points as originating from the same internal level in the QDs. We thus decide to discard the data relative to the point at $V_m = 5.5$ V as an artefact and assign to the QDs + AlP system a localization energy of $1.14(\pm 0.04)$ eV with an associated capture cross-section of $7(\pm 6) \times 10^{-10}$ cm$^2$ (from evaluation of the data relative to the points at $V_m = 5.0$ V and $V_m = 4.5$ V, grouped together). We attribute the $0.90 \pm 0.01$ eV localization visible for $V_r \leq 2.5$ V to the effect of the barrier.

The number of holes per QD involved in each charge-selective DLTS measurement can be extracted directly from the maximum amplitude of the DLTS signal. Since we are observing the charging and discharging of a single internal level of the QDs, we expect 2 holes per QD to be involved in the process. Assuming a density of QDs of $1 \times 10^{10}$ cm$^{-2}$, which is an order of magnitude lower than previously reported,\textsuperscript{11} we do indeed obtain a value of about 2 for each reverse bias point (average: $2.1 \pm 0.3$ holes/QD).

A similar charge-selective DLTS measurement was carried out also on sample B. The value of the activation energy oscillates around 0.52($\pm 0.05$) eV for all voltages (see Fig. 3(c)), with an average capture cross-section of $2.1(\pm 0.6) \times 10^{-10}$ cm$^2$ (Fig. 3(d)). This localization effect is interpreted as caused by the barrier, for which we expect a height of about 0.50 eV.\textsuperscript{20} This value is 0.38 eV short of the 0.90 eV seen in sample C at low voltages. The reason is that the value of 0.90 eV does not represent the height of the AlP barrier alone, but rather the combined effect of the barrier and the QDs. The highest bound level in the QDs is deeper into the bandgap than the top of the valence band and therefore contributes additional localization energy (see Fig. 2 for a sketch of the emission process).

We can estimate the storage time at room temperature using Eq. (1). The value for Sample C, which amounts to 230($\pm 60$) s, is plotted in Fig. 4 together with values already available in literature.\textsuperscript{5,6,9,21,22} The large error associated with the estimate (26%) is due to the low accuracy in the estimate of the capture cross-section, which is an intrinsic
problem of evaluation using the Arrhenius plot. Nonetheless, even within the error margin the storage time of Sample C represents an improvement of 2 orders of magnitude compared to the previous record of 1.6 s for GaSb QDs in GaAs with an Al$_{0.35}$Ga$_{0.65}$As barrier.\textsuperscript{6} It is interesting to note that a localization energy in the order of the one demonstrated in this work (1.14 eV) would already suffice for non volatility (i.e., storage time $> 10 \text{ yr}$), provided that the capture cross section was $ \leq 4 \times 10^{-14} \text{cm}^2$. The most viable way to achieve longer storage times is by further increasing the localization energy using different material combinations. Good candidate materials are, for example, GaSb/Al$_{0.51}$In$_{0.49}$P QDs (estimate: $E_{\text{loc}} \approx 1.25 \text{ eV}$) and GaSb/GaP QDs (estimate: $E_{\text{loc}} = 1.4 \text{ eV}$).\textsuperscript{20,24}

Another way of increasing the storage time would be engineering of the capture cross-section. This parameter depends on several factors, including hole wave functions in the QDs, coupling to phonons, and Auger scattering. An effective method of modelling these effects with relation to the capture cross section has yet to be developed. A way to shrink the capture cross-section could be to reduce the size of the QDs. This can be accomplished by reducing the length of the growth interruption after QD deposition during epitaxial growth,\textsuperscript{11} but at the expense of a reduced localization energy of charge carriers in the QDs. Further investigation is needed before successfully employing this method for capture cross-section engineering.

In summary, we studied the electrical properties of 3 GaP samples consisting of an $n^+$-diode containing a sole AlP barrier or In$_{0.35}$Ga$_{0.65}$As QDs with an AlP barrier, alongside a reference sample. We used DLTS to determine the activation energies for the latter two structures, which are 0.52(±0.05) eV and 1.14(±0.04) eV, respectively. Subtracting the former figure from the latter yields an estimate for the localization energy of simple In$_{0.5}$Ga$_{0.5}$As QDs in GaP of 0.62(±0.06) eV. This value is in good agreement with the theoretically expected 0.6 eV.\textsuperscript{7} Moreover, the increase from the 0.49 eV we measured previously for In$_{0.25}$Ga$_{0.75}$As QDs in GaP\textsuperscript{9} is compatible with the fact that the previous measurement was a mean activation energy and that the In content has been increased from 25% to 50%.\textsuperscript{7} We demonstrated a hole storage time at room temperature of 230(±60) s for the sample containing QDs and an AlP barrier. In order to further increase the localization energy and the storage time, we propose keeping GaP as the matrix material and advancing the material system to GaSb/(Ga,Al)P QDs.

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